

Dual N-Channel 40-V MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)	Q _g (Typ.)			
40	0.016 at V _{GS} = 10 V	8	56			
40	0.019 at V _{GS} = 4.5 V	8	56			

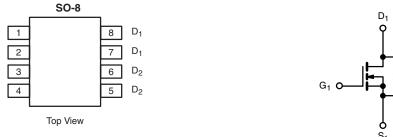
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
- UIS Tested



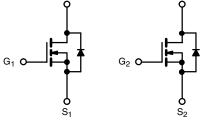
APPLICATIONS

• CCFL Inverter



Ordering Information: Si4904DY-T1-E3 (Lead (Pb)-free)

Si4904DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V_{DS}	40	W		
Gate-Source Voltage	V_{GS}	± 16	V		
	T _C = 25 °C		8		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	I _D	8		
Continuous Diam Current (1) = 130 °C)	T _A = 25 °C	'D	8 ^{b, c}		
	T _A = 70 °C		6.5 ^{b, c}		
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	20	Α	
Source-Drain Current Diode Current	T _C = 25 °C	I _S	2.7		
Source-Drain Guiterit Diode Guiterit	T _A = 25 °C	'S	1.6 ^{b, c}		
Pulsed Source-Drain Current	I _{SM}	20			
Single Pulse Avalanche Current		I _{AS}	20		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	20		
	T _C = 25 °C		3.25		
Maximum Power Dissipation	T _C = 70 °C	P _D	2.10	W	
Maximum Fower Dissipation	T _A = 25 °C	' D	2.0 ^{b, c}	٧٧	
	T _A = 70 °C	Ī	1.25 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	45	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady-State	R _{thJF}	29	38] 5/44		

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 120 °C/W.

Si4904DY

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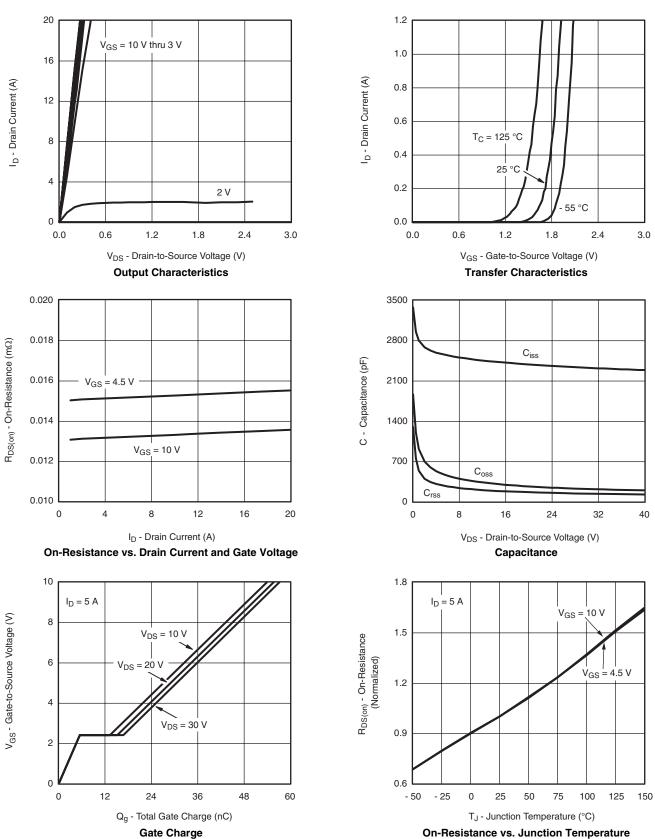
SPECIFICATIONS $T_J = 25 ^{\circ}C$, Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit	
Static				.,,,,			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	40			V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA		40		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 4.8			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.8		2.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$			100	nA	
		V _{DS} = 40 V, V _{GS} = 0 V	1		1	 	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V, T _J = 55 °C			10	μΑ	
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
		V _{GS} = 10 V, I _D = 5 A		0.013	0.016		
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 4 A		0.015	0.019	Ω	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 5 A		23		S	
Dynamic ^a				<u> </u>			
Input Capacitance	C _{iss}			2390			
Output Capacitance	C _{oss}	N-Channel		270		pF	
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, I_{D} = 1 \text{ MHz}$		165			
		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$		56	85		
Total Gate Charge	Q_g	Q _g		26	40	1	
Gate-Source Charge	Q_{gs}	N-Channel $V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		5.5		nC	
Gate-Drain Charge	Q_{gd}	V _{DS} = 20 V, V _{GS} = 4.3 V, I _D = 3 A		9.7			
Gate Resistance	R_g	f = 1 MHz		2.6	4.0		
Turn-On Delay Time	t _{d(on)}			15	23	1	
Rise Time	t _r	N-Channel		20	30		
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 20 \text{ V}, R_L = 4 \Omega$ $I_D \cong 5 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_q = 1 \Omega$		56	85		
Fall Time	t _f	-D		10	15		
Turn-On Delay Time	t _{d(on)}			88	135	ns	
Rise Time	t _r	N-Channel $V_{DD} = 20 \text{ V, R}_{L} = 4 \Omega$		117	180		
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 20 \text{ V, } R_L = 4.52$ $I_D \cong 5 \text{ A, } V_{GEN} = 4.5 \text{ V, } R_q = 1 \Omega$		62	95		
Fall Time	t _f	- D 7 , TGEN I, I I I		19	30		
Drain-Source Body Diode Characterist	cs						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.7	۸	
Pulse Diode Forward Current ^a	I _{SM}				20	Α	
Body Diode Voltage	V_{SD}	I _S = 1.5 A		0.69	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			62	95	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	N-Channel		62	95	nC	
Reverse Recovery Fall Time	t _a	I _F = 2 A, dI/dt = 100 A/μs, T _J = 25 °C		26		~0	
Reverse Recovery Rise Time	t _b	-		36		nS	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



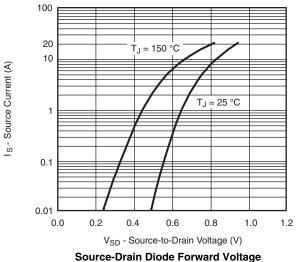


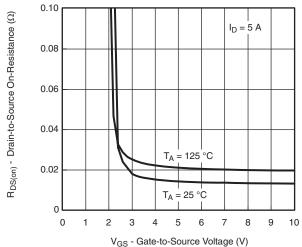
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

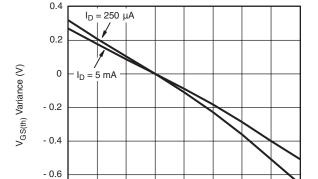


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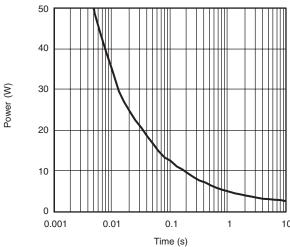
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On-Resistance vs. Gate-to-Source Voltage



T_J - Temperature (°C) **Threshold Voltage**

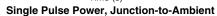
50

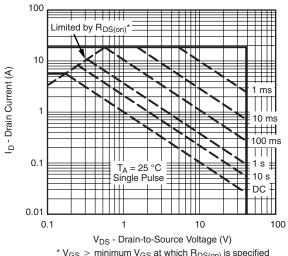
75

100

150

125





* $V_{GS} > \mbox{minimum} \ V_{GS}$ at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

- 0.8

- 50

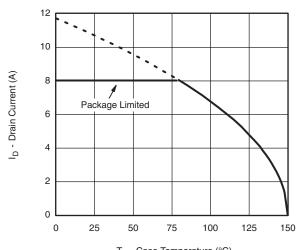
- 25

0

25

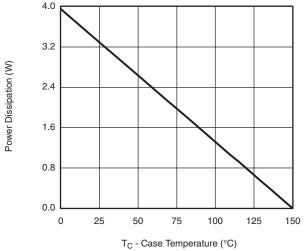


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

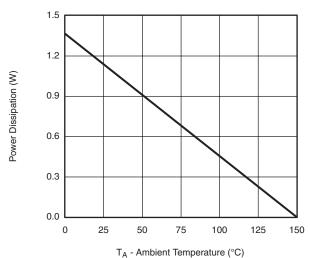


T_C - Case Temperature (°C)









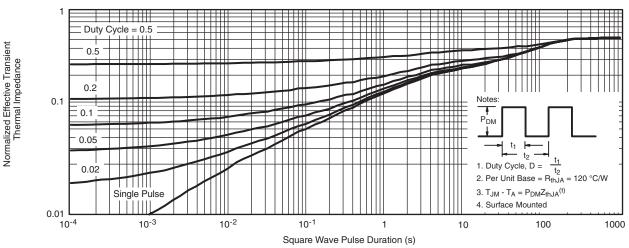
Power Derating, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

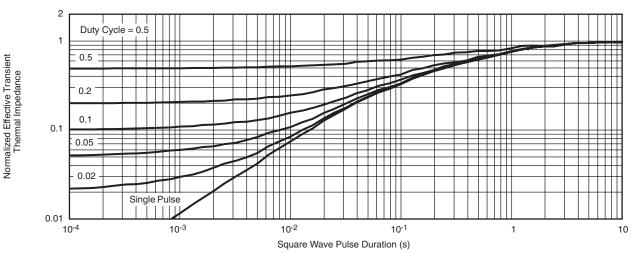
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



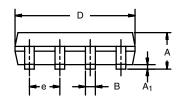
Normalized Thermal Transient Impedance, Junction-to-Case

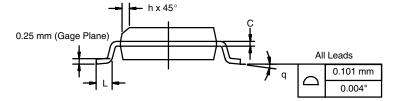
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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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APPLICATION NOTE



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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